UM11183

KITFS85SKTEVM evaluation board

Rev. 2.0 — 20 February 2019

User guide



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KITFS85SKTEVM evaluation board

1 Introduction

This document is the user guide for the KITFS85SKTEVM evaluation board. This document is intended for the engineers involved in the evaluation, design, implementation, and validation of FS8500 Fail-safe system basis chip with multiple SMPS and LDO.

The scope of this document is to provide the user with information to evaluate the FS8500 Fail-safe system basis chip with multiple SMPS and LDO. This document covers connecting the hardware, installing the software and tools, configuring the environment and using the kit.

The KITFS85SKTEVM enables development on FS84/FS85 family of devices. The kit can be connected to the FlexGUI software which allows you to play with registers, try OTP configurations, and burn the part.

The devices can be placed and removed easily from the board by using the socket. The device OTP can be burned three times, which provides a good flexibility. This board supports FS84/FS85 family of devices.

2 Finding kit resources and information on the NXP web site

NXP Semiconductors provides online resources for this evaluation board and its supported device(s) on http://www.nxp.com.

The information page for KITFS85SKTEVM evaluation board is at http://www.nxp.com/KITFS85SKTEVM. The information page provides overview information, documentation, software and tools, parametrics, ordering information and a **Getting Started** tab. The **Getting Started** tab provides quick-reference information applicable to using the KITFS85SKTEVM evaluation board, including the downloadable assets referenced in this document.

2.1 Collaborate in the NXP community

The NXP community is for sharing ideas and tips, ask and answer technical questions, and receive input on just about any embedded design topic.

The NXP community is at http://community.nxp.com.

3 Getting ready

Working with the KITFS85SKTEVM requires the kit contents, additional hardware and a Windows PC workstation with installed software.

3.1 Kit contents

- · Assembled and tested evaluation board in an anti-static bag
- 3.0 ft USB-STD A to USB-B-mini cable
- Two connectors, terminal block plug, 2 pos., str. 3.81 mm
- Three connectors, terminal block plug, 3 pos., str. 3.81 mm
- Jumpers mounted on board

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3.2 Additional hardware

In addition to the kit contents, the following hardware is necessary or beneficial when working with this kit.

Power supply with a range of 8.0 V to 60 V and a current limit set initially to 1.0 A

3.3 Windows PC workstation

This evaluation board requires a Windows PC workstation. Meeting these minimum specifications should produce great results when working with this evaluation board.

• USB-enabled computer with Windows 7 or Windows 10

3.4 Software

Installing software is necessary to work with this evaluation board. All listed software is available on the evaluation board's information page at http://www.nxp.com/ KITFS85SKTEVM or from the provided link.

- · FlexGUI latest version
- FS85_FS84_OTP_Config.xlsm
- Java installation https://www.oracle.com/technetwork/java/javase/downloads/jre8-downloads-2133155.html

4 Getting to know the hardware

The KITFS85SKTEVM provides flexibility to play with all the features of the device and make measurements on the main part of the application. The KL25Z MCU installed on the board, combined with the FlexGUI software allows access to the registers in read and write mode. All regulators are accessible through connectors. Nonuser signals, like DC/DC switcher node are mapped on test points. Digital signals (SPI, I2C, RSTb, etc.) are accessible through connectors. Wake1 pin has a switch to control (Ignition) them. A V_{BAT} switch is available to power On or Off the device.

The main purpose of this kit is to burn the OTP configuration. This kit can be operated in Emulation mode or in OTP mode. In Emulation mode, as long as the power is supplied, the board configuration stays valid. The OTP mode uses the fused configuration. The device can be fused three times. In OTP mode, the device always starts with the fused configuration, except if the user wants to overwrite OTP configuration using Emulation mode. This board is able to fuse the OTP without any extra tools or board.

Note: Due to the socket, this kit is not optimized for performance measurement or current higher than 1.0 A.

4.1 Kit overview

The KITFS85SKTEVM is a hardware evaluation tool that allows OTP burning. Due to the socket, the FS84/FS85 part can be configured without the need to solder it. Devices can be programmed three times (see <u>Section 7.3 "Programming the device with an OTP configuration"</u>).

An Emulation mode is possible to test as many configurations as needed.

An external LDO provides VDDI2C voltage with a choice of 1.8 V or 3.3 V (default). VDDIO is assigned by default to VDDI2C. From USB voltage, an external DC/DC

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generates the OTP programming voltage (8.0 V) without any need for an external power supply.

4.1.1 KITFS85SKTEVM features

- · VBAT power supply connectors (Jack and Phoenix)
- VPRE output capability up to 1.0 A (socket limit)
- VBUCK1/2 in Standalone (default) or Multiphase mode
- VBUCK3
- VBOOST 5.0 V or 5.74 V
- LDO1 and LDO2, from 1.1 V to 5.0 V
- · Ignition key switch
- · FS0B external safety pin
- Embedded USB connection for easy connection to software GUI (access to SPI/I2C bus, IOs, RSTB, FS0B, INTB, Debug, MUX_OUT, regulators)
- LEDs that indicate signal or regulator status
- · Support OTP fuse capabilities
- · USB connection for register access, OTP emulation and programming
- · Voltage monitoring jumper setting

Note: Due to the socket, all current capabilities are limited to 1.0 A.

4.1.2 VMON board configuration

The VMONx configuration is highly dependent on the use case. This kit is delivered with a default configuration shown in <u>Figure 2</u>.

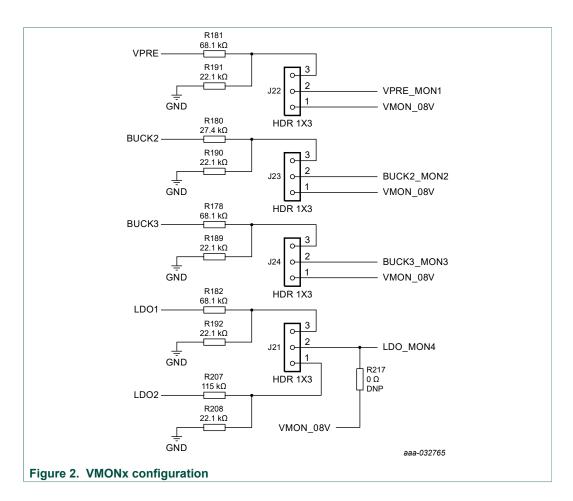
This configuration supports the following mapping:

- VPRE, assigned to VMON1; Bridge resistor set for 3.3 V
- BUCK2, assigned to VMON2; Bridge resistor set for 1.8 V
- BUCK3, assigned to VMON3; Bridge resistor set for 3.3 V
- LDO1, assigned to VMON4; Bridge resistor set for 3.3 V
- LDO2, assigned to VMON4; Bridge resistor set for 5.0 V

LDO1 and LDO2 use the same VMON, a reassignement is necessary to monitor both.

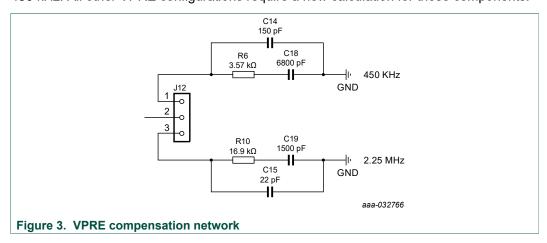
Due to the jumpers, VMONx can be tied to a 0.8 V to force a good voltage at pin level. This behaves like hardware disabling and makes debug easy in some cases.

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4.1.3 VPRE compensation network

This board is delivered with a VPRE compensation network defined for VPRE 4.1 V at 450 kHz. All other VPRE configurations require a new calculation for these components.



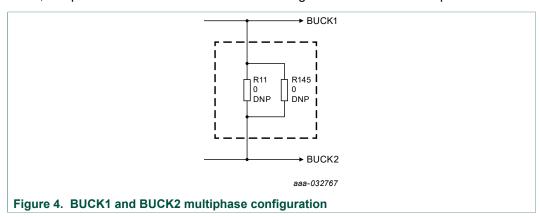
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Table 1. Compensation network

Components	VPRE 450 kHz	VPRE 2.2 MHz
C18/C19	6.8 nF	1.5 nF
C14/C15	150 pF	22 pF
R6/R10	3.57 kΩ	16.9 kΩ
LPRE	4.7 μH or 6.8 μH	1.5 μH , 2.2 μH or 4.7 μH

4.1.4 BUCK1 and BUCK2 multiphase configuration

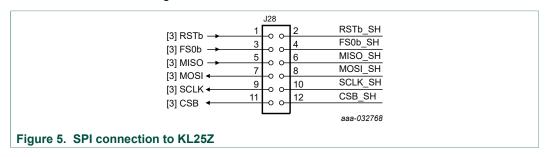
The board is designed to work independently with BUCK1 and BUCK2. Due to R11 and R145, it is possible to connect both connectors together and work in multiphase.



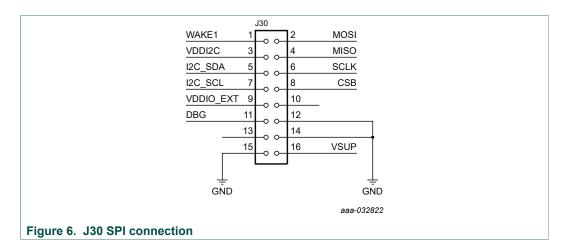
4.1.5 SPI/I2C

The SPI and I2C buses are connected to KL25Z MCU. The user can use either one or the other. The choice can be done at start of the FlexGUI or at any time after launch (see Section 8 "Using FlexGUI").

This kit uses a KL25Z MCU to communicate with FlexGUI. However, if the user wants to connect the SPI to another MCU, this is possible. In this case, remove J28 and appropriate jumpers to disconnect the KL25Z MCU (see Figure 5) and connect the external MCU on J30 connector as shown in Figure 6. In addition to this change, make sure that the VDDIO voltage domain is the same on MCU side and SBC side.



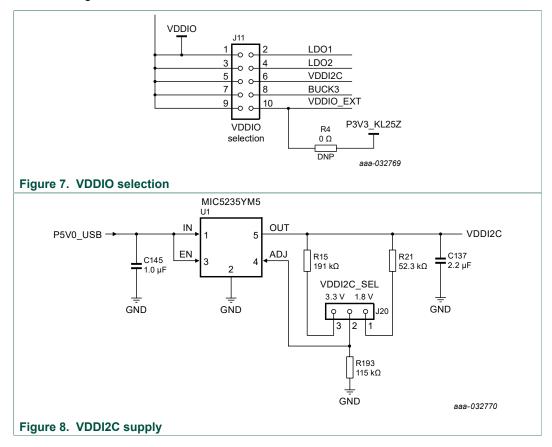
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4.1.6 VDDI2C

As an option, an external LDO is provided to feed VDDI2C. This LDO can also be used to feed VDDIO, which is the default implementation.

The I2C is compatible with 1.8 V or 3.3 V, while VDDIO is compatible with 3.3 V and 5.0 V. For this reason, the LDO default configuration is 3.3 V. The LDO is supplied by 5.0 V coming from the USB.



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4.2 Device OTP user configuration

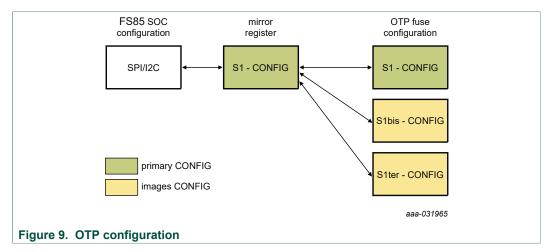
It is recommended to learn about OTP before operating with the device. The device has a high level of flexibility due to parameter configuration available in the OTP. This impacts the functionality of the device. It is key to understand how OTP parameters can be programmed, the interaction with mirror registers and the FS85 SoC.

The OTP related operations can be performed either in Emulation mode, where the product uses a given configuration as long as power supply is not switched Off or from OTP fuse content that is valid even after a power down/power up sequence.

4.2.1 OTP and mirrors registers

There are two OTP blocks in the device. One is for the main section, and the other for the fail-safe. During configuration, each of them are using dedicated sectors. The OTP configuration scheme is shown in Figure 9 (same implementation for main and fail-safe).

The device can be fused three times using mirror registers. The user can first load the mirror register content with the desired contents, then decide either to use the device in Emulation mode or to burn the next sector. The first sector to be burned is S1, the second S1bis and the third S1ter. FlexGUI automatically manages the next sector to be burned. It is not possible to revert back to the previous sector. When the user reaches the sector S1ter, there no other possibility for burn, however emulation mode is still available.



At boot, the content of the valid sector is loaded into the Mirror Register Sector 1. The mirror register content is accessible from FlexGUI by using specific SPI/I2C commands. The mirror configuration is managed by the FlexGUI, which eases the access.

4.2.2 OTP hardware implementation

To work in OTP emulation or OTP programming, it is required to start the device in Debug mode.

<u>Figure 10</u> shows the sequence to be followed to enter in Debug mode. The voltage sequence on the kit is done using switches installed on the board, while the OTP registers configuration is managed by the FlexGUI GUI. This is described in detail in the following sections.

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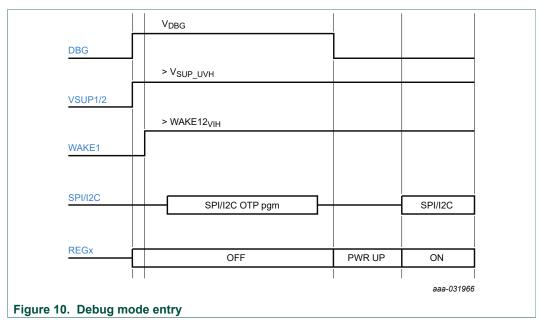
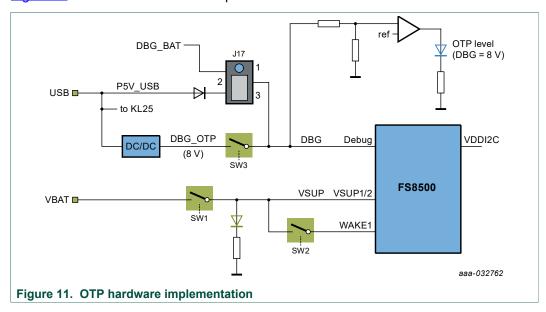


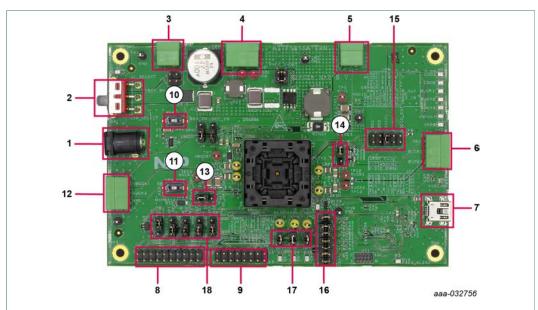
Figure 11 shows the hardware kit implementation.



4.3 Kit featured components

<u>Figure 12</u> identifies important components on the board and <u>Table 2</u> provides additional details on these components.

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- 1. V_{BAT} Jack connector
- 2. V_{BAT} three position switch
- 3. V_{BAT} Phoenix connector
- 4. LDO1/LDO2 power supplies
- 5. VPRE power supply
- 6. BUCK1/BUCK2 power supply
- 7. USB connector (for FlexGUI control)
- 8. Debug connectivity
- 9. Programming
- 10. Wake1 switch
- 11. OTP burning voltage switch
- 12. VBOOST and BUCK3 power supply
- 13. DEBUG voltage source
- 14. Compensation network selection
- 15. VDDIO selection
- 16. SPI / RSTb / FS0b connection to MCU
- 17. RSTb, INTb and FS0b signals
- 18. VMONx, VDDI2C selection

Figure 12. Evaluation board featured component locations

Table 2. Evaluation board board component descriptions

Number	Description
1	V _{BAT} Jack connector
2	V _{BAT} three position switch Left position: board supplied by Jack connector Middle position: board not supplied Right position: board supplied by Phoenix connector
3	V _{BAT} Phoenix connector
4	LDO1/LDO2 power supply
5	VPRE power supply
6	BUCK1/BUCK2 power supply
7	USB connector (for FlexGUI control)

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Number	Description
8	Debug connectivity. Access to: VSUP, GND FOUT/FIN PGOOD/RST/FS0b FCCUx Wake2 PSYNC, ERRMON, AMUX VMONx
9	Programming SPI bus I2C bus Debug pin VPRE, VSUP, GND
10	Wake1 switch
11	OTP burning voltage switch
12	VBOOST and BUCK3 power supply
13	DEBUG voltage source either from USB (recommended) or from VSUP
14	VPRE compensation network selection, either 2.2 MHz or 450 kHz
15	VDDIO source from device regulators or external sources
16	SPI, RSTb or FS0b can be disconnected between device and MCU
17	RSTb, INTb and FS0b signals available here (device pin level)
18	Allows to select VMON from regulators or a fix 0.8 V VDDI2C can be selected either 1.8 V or 3.3 V

4.3.1 FS8500/FS8400: Fail-safe system basis chip with multiple SMPS and LDO

4.3.1.1 General description

This device family is part of a global platform FS84 (fit for ASIL B) and FS85 (fit for ASIL D), pin to pin and software compatible. The FS85/FS84 is an automotive functionally safe multi-output power supply integrated circuit, with focus on Radar, Vision, ADAS domain controller, Radio and Infotainment applications. It includes multiple switch mode and linear voltage regulators. It offers external frequency synchronization input and output, for optimized system EMC performance.

The FS85/FS84 includes enhanced safety features, with fail-safe output, becoming a full part of a safety-oriented system partitioning, covering both ASIL B and ASIL D safety integrity level. It is developed in compliance with ISO 26262 standard. Several device versions are available, offering choice in number of output rails, output voltage setting, operating frequency and power up sequencing, to address multiple applications.

4.3.1.2 Features

- 60 V DC maximum input voltage for 12 V and 24 V applications
- VPRE synchronous buck controller with external MOSFETs. Configurable output voltage, switching frequency, and current capability up to 10 A peak.
- Low voltage integrated synchronous BUCK1 converter, dedicated to MCU core supply with SVS capability. Configurable output voltage and current capability up to 3.6 A peak.

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- Based on part number: low voltage integrated synchronous BUCK2 converter. Configurable output voltage and current capability up to 3.6 A peak. Multi-phase capability with BUCK1 to extend the current capability up to 7.2 A peak on a single rail. Static voltage scaling capability.
- **Based on part number**: low voltage integrated synchronous BUCK3 converter. Configurable output voltage and current capability up to 2.5 A typical peak.
- BOOST converter with integrated low-side switch. Configurable output voltage and max input current up to 1.5 A peak.
- EMC optimization techniques including SMPS frequency synchronization, spread spectrum, slew rate control, manual frequency tuning
- 2x linear voltage regulators for MCU IOs and ADC supply, external physical layer. Configurable output voltage and current capability up to 400 mA DC.
- Standby OFF mode with very low sleep current (10 μA typ)
- 2x input pins for wake-up detection and battery voltage sensing
- · Device control via 32 bits SPI or I2C interface with CRC
- Power synchronization pin to operate 2x FS85 devices or FS85 plus an external PMIC
- Scalable portfolio from ASIL B to ASIL D with independent monitoring circuitry, dedicated interface for MCU monitoring, simple and challenger watchdog function, power good, reset and interrupt, built-in self-test, fail-safe output
- Configuration by OTP programming. Prototype enablement to support custom setting during project development in engineering mode.

4.3.2 Indicators

The following LEDs are provided as visual output devices for the evaluation board:

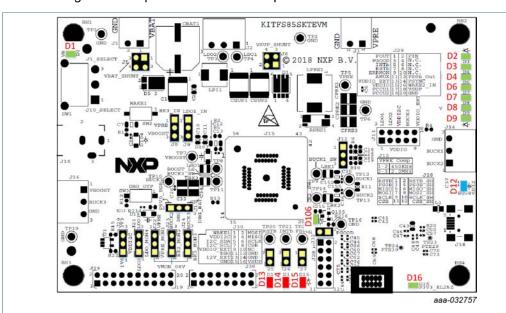


Figure 13. Evaluation board indicator locations

Table 3. Evaluation board indicator descriptions

Label	Name	Color	Description
D1	V _{BAT}	Green	V _{BAT} On
D2	LDO1	Green	LDO1 On
D3	LDO2	Green	LDO2 On

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Label	Name	Color	Description
D4	BUCK1	Green	BUCK1 On
D6	BUCK2	Green	BUCK2 On
D7	BUCK3	Green	BUCK3 On
D8	VBOOST	Green	VBOOST On
D9	V _{PRE}	Green	V _{PRE} On
D12	DBG > 8.0 V	Blue	DBG pin voltage > 8.0 V (OTP programming)
D13	RSTb	Red	RSTb asserted (logic level = 0)
D14	INTb	Red	INTb asserted (logic level = 0)
D15	FS0b	Red	FS0b asserted (logic level = 0)
D16	P3V3_KL25	Green	P3V3_KL25 On
D106	PGOOD	Green	PGOOD released

4.3.3 Connectors

Figure 14 shows the location of connectors on the board.

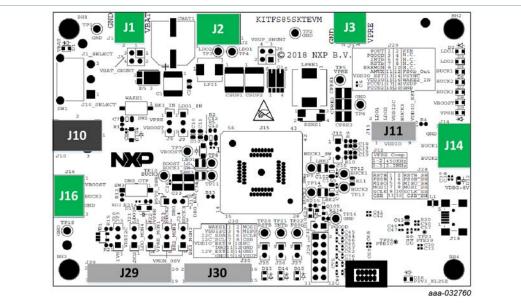


Figure 14. Evaluation board connector locations

4.3.3.1 V_{BAT} connector (J1)

VBAT connects to the board through Phoenix connector (J1).

Table 4. V_{BAT} Phoenix connector (J1)

Schematic label	Signal name	Description
J1-1	V _{BAT}	Battery voltage supply input
J1-2	GND	Ground

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4.3.3.2 Output power supply connectors

Table 5. BUCK1/BUCK2 connector (J14)

Schematic label	Signal name	Description
J14-1	BUCK2	BUCK2 power supply output
J14-2	BUCK1	BUCK1 power supply output
J14-3	GND	Ground

Table 6. VBOOST/BUCK3 connector (J16)

Schematic label	Signal name	Description
J16-1	VBOOST	VBOOST output
J16-2	BUCK3	BUCK3 power supply output
J16-3	GND	Ground

Table 7. LDO1/LDO2 connector (J2)

Schematic label	Signal name	Description
J2-1	LDO1	LDO1 power supply output
J2-2	LDO2	LDO2 power supply output
J2-3	GND	Ground

Table 8. VPRE connector (J3)

Schematic label	Signal name	Description
J3-1	VPRE	VPRE power supply output
J3-2	GND	Ground

4.3.3.3 Debug connector (J29)

Table 9. Debug connector (J29)

Schematic label	Signal name	Description
J29-1	FOUT	Frequency synchronization output
J29-2	FIN	Frequency synchronization input
J29-3	PGOOD	Power GOOD
J29-4	n.c.	not connected
J29-5	INTB	Interrupt, active low
J29-6	n.c.	not connected
J29-7	RSTb	Reset, active low
J29-8	n.c.	not connected
J29-9	ERRMON	Error monitoring
J29-10	n.c.	not connected
J29-11	AMUX	Analog multiplexer
J29-12	FS0b_Out	Fail-safe, active low
J29-13	VDDIO_EXT	VDDIO external reference

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Schematic label	Signal name	Description
J29-14	PSYNC	Power synchronization
J29-15	VDDIO	VDDIO used by FS85
J29-16	WAKE2_IN	Wake2 input
J29-17	FCCU1	Fault collector control unit 1
J29-18	VSUP	VSUP power supply
J29-19	FCCU2	Fault collector control unit 2
J29-20	GND	Ground

4.3.3.4 Program connector (J30)

Table 10. Program connector (J30)

Schematic label	Signal name	Description			
J30-1	WAKE1	WAKE1 input			
J30-2	MOSI	SPI master output slave input			
J30-3	VDDI2C	VDDI2C voltage			
J30-4	MISO	SPI master input slave output			
J30-5	I2C_SDA	I2C serial data			
J30-6	SCLK	SPI clock			
J30-7	I2C_SCL	I2C serial clock			
J30-8	CSB	SPI chip select			
J30-9	n.c.	not connected			
J30-10	VPRE	VPRE output			
J30-11	DBG	Connected to Debug pin			
J30-12	GND	Ground			
J30-13	n.c.	not connected			
J30-14	VSUP	Connected to VSUP pin			
J30-15	GND	Ground			
J30-16	GND	Ground			

4.3.4 Test points

The following test points provide access to various signals to and from the board.

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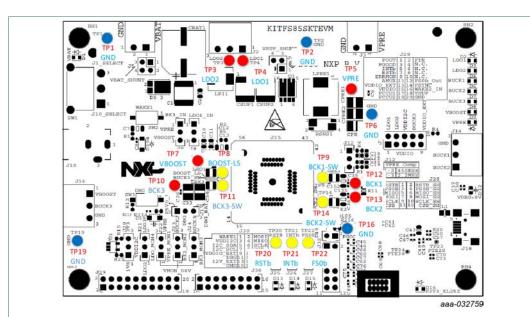


Figure 15. Evaluation board test points

Table 11. Evaluation board test point descriptions

Test point name	Signal name	Description		
TP1	GND	Ground		
TP2	GND	Ground		
TP3	LDO2	LDO2 regulator output		
TP4	LDO1	LDO1 regulator output		
TP5	VPRE	VPRE DC/DC regulator output		
TP6	GND	Ground		
TP7	VBOOST	VBOOST DC/DC output		
TP8	BOOST_LS	VBOOST low-side switcher		
TP9	BUCK1_SW	BUCK1 switcher		
TP10	BUCK3	BUCK3 DC/DC regulator output		
TP11	BUCK3_SW	BUCK3 switcher		
TP12	BUCK1	BUCK1 DC/DC regulator output		
TP13	BUCK2	BUCK2 DC/DC regulator output		
TP14	BUCK2_SW	BUCK2 switcher		
TP16	GND	Ground		
TP19	GND	Ground		
TP20	RSTb	Reset		
TP21	INTb	Interruption		
TP22	FS0b	Fail-safe output		

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4.3.5 Jumpers

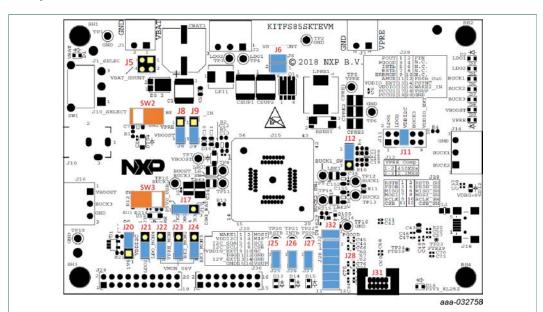


Figure 16. Evaluation board jumper locations

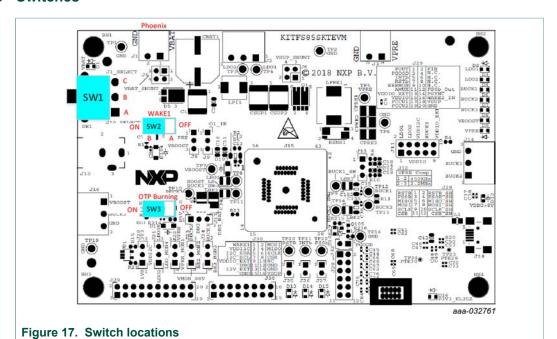
Table 12. Evaluation board jumper descriptions

Name	Function	Pin number	Jumper/pin function
J5	V _{RAT} shunt	1-2	Shunt switch SW1 for current > 5.0 A
33	V _{BAT} Siluiti	3-4	Shunt switch SW1 for current > 5.0 A
J6	V _{SUP} shunt	1-2	For current measurement (insert amperemeter)
30	VSUP SHUIL	3-4	For current measurement (insert amperemeter)
J8	BUCK3 input	1-2	BUCK_INQ tied to VPRE
30	воско прис	2-3	BUCK_INQ tied to VBOOST
J9	LDO1 input	1-2	LDO1_IN connected to V _{PRE}
0.9	LDO I IIIput	2-3	LDO1_IN connected to VBOOST
J10	V _{BAT} jack	Jack	Used for V _{BAT} supply using jack connector
		1-2	VDDIO tied to LDO1
		3-4	VDDIO tied to LDO2
J11	VDDIO selection	5-6	VDDIO tied to VDDI2C (provided by external regulators)
		7-8	VDDIO tied to BUCK3
		9-10	VDDIO tied to VDDIO external
J17	Dobug	1-2	Debug pin tied to P5V0_USB (5.0 V provided by USB connector)
317	Debug	2-3	Debug pin tied to V _{BAT} (through external protection) Do not use for OTP burning
J20	VMON4	1-2	VMON4 tied to LDO2
J20	VIVION4	2-3	VMON4 tied to LDO1
J22	VMON1	1-2	VMON1 tied to 0.8 V
JZZ	VIVIOINI	2-3	VMON1 tied to VPRE

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Name	Function	Pin number	Jumper/pin function
J23	VMON2	1-2	VMON2 tied to 0.8 V
J23		2-3	VMON2 tied to BUCK2
J24	VMON3	1-2	VMON3 tied to 0.8 V
324	VIVIONS	2-3	VMON3 tied to BUCK3
J25	RSTb	1-2	Reset LED Enabled when jumper is plugged
J26	INTb	1-2	Interrupt LED Enabled when jumper is plugged
J27	FS0b	1-2	FS0b LED Enabled when jumper is plugged
J29	_	_	_
J30	_	_	_
J31	_	_	Use only during board manufacturing
J32	PGOOD	1-2	PGOOD LED Enabled when jumper is plugged

4.3.6 Switches



-

 Table 13. SW3

 Position
 Function
 Description

 RIGHT
 OTP programming Off
 OTP burning not possible

 LEFT
 OTP programming On
 8.0 V on DBG pin allows OTP burning (blue LED turns On to indicate this state)

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Table 14. SW2

Position	Function	Description	
OFF	WAKE1 open	Wake1 pin not connected to V _{SUP}	
ON	WAKE1 closed	Wake1 pin connected to V _{SUP}	

Table 15. SW1

Position	Function	Description		
TOP	VBAT On	VBAT from J1		
MIDDLE	VBAT Off	Board not supplied		
воттом	VBAT On	VBAT from J10		

4.4 Schematic, board layout and bill of materials

The schematic, board layout and bill of materials for the KITFS85SKTEVM evaluation board are available at http://www.nxp.com/KITFS85SKTEVM.

5 Installing and configuring software and tools

This development kit uses FlexGUI software. FlexGUI software is based on Java JRE.

Preparing the Windows PC workstation consists of three steps.

- 1. Install the appropriate Java SE Runtime Environment (JRE).
- 2. Install Windows 7 FlexGUI driver.
- 3. Install FlexGUI software package.

5.1 Installing the Java JRE

- 1. Download Java JRE (Java SE Runtime Environment), available at http://www.oracle.com/technetwork/java/javase/downloads/jre8-downloads-2133155.html (8u162 or newer).
- 2. Open the installer and follow the installation instructions.
- 3. Following the successful installation, restart the computer.

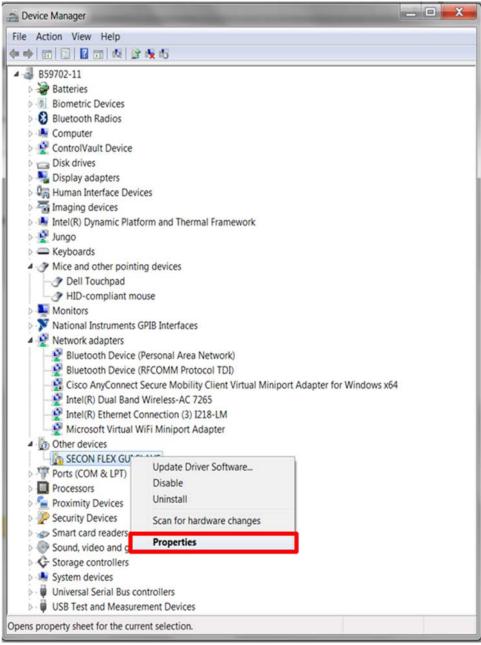
5.2 Installing Windows 7 FlexGUI driver

On Windows 7 PCs, a virtual COM port installation is required. Install the Windows 7 FlexGUI driver using the following procedure.

Note: On Windows 10, it is not necessary to install virtual com port as Windows 10 uses a generic COM port driver.

- Connect the kit to the computer as described in <u>Section 6 "Configuring the hardware for startup"</u>
- 2. On the Windows PC, open the **Device Manager**.
- 3. In the **Device Manager** window, right-click on **SECON FLEX GUI SLAVE**, and then select **Properties**.

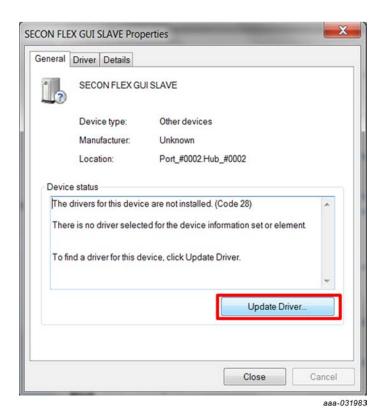
KITFS85SKTEVM evaluation board



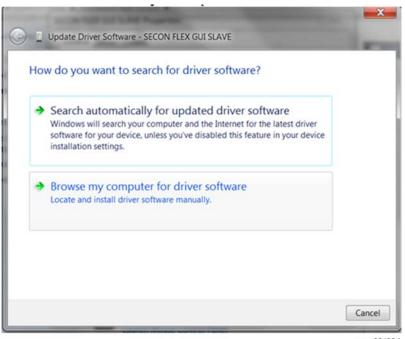
aaa-031982

4. In the SECON FLEX GUI SLAVE Properties window, click Update Driver.

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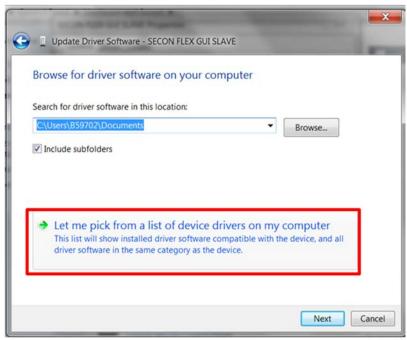
5. in the Update Software Driver window, select Browse my computer for driver software.



aaa-031984

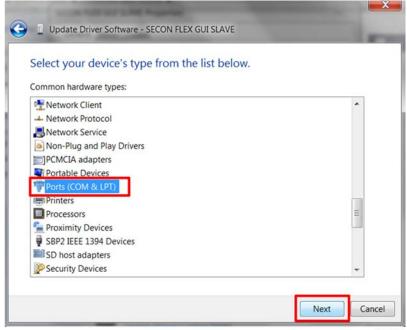
KITFS85SKTEVM evaluation board

Select Let me pick from a list of device drivers on my computer, and then click Next.



aaa-031985

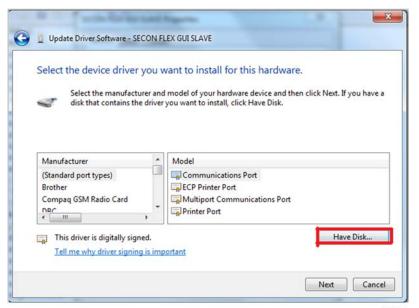
7. Select Ports (COM & LPT) from the list, and then click Next.



aaa-031986

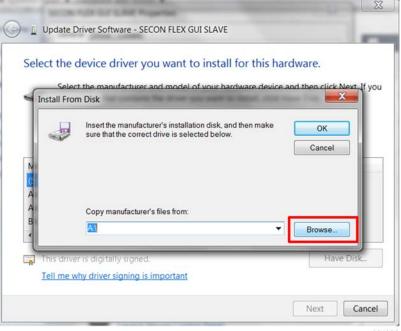
8. Click Have Disk.

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aaa-031987

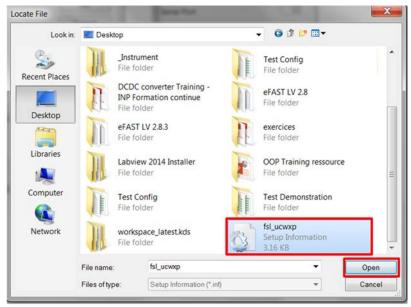
9. Click Browse.



aaa-031988

10.In the Locate File window, locate and select fsl_ucwxp, and then click Open.

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aaa-031989

11.In the Install from Disk window, click OK.



aaa-031990

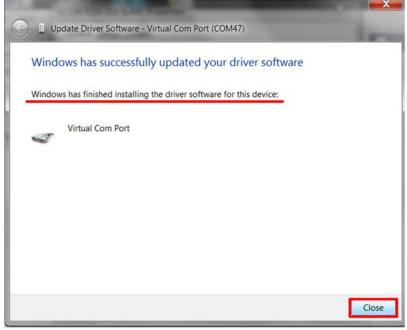
12.If prompted, in the **Windows Security** window, click **Select this driver software** anyway.

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aaa-031991

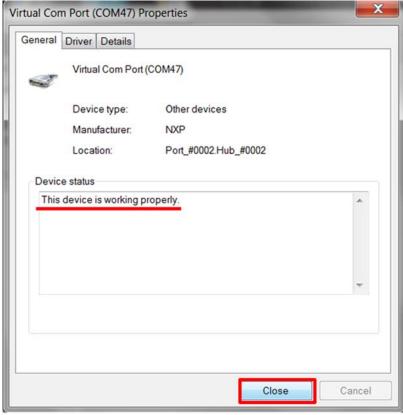
13. Close the window when the installation is complete.



aaa-031992

14.In the **Virtual Com Port Properties** window, verify that the device is working properly, and then click **Close**.

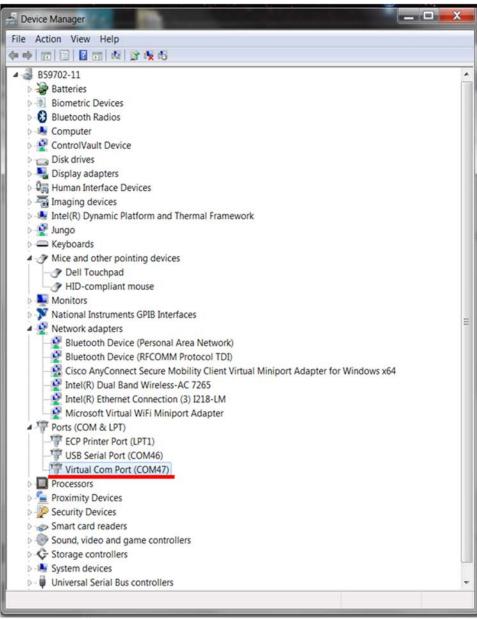
KITFS85SKTEVM evaluation board



aaa-031993

The Virtual Com Port appears in the Device Manager window.

KITFS85SKTEVM evaluation board



aaa-031994

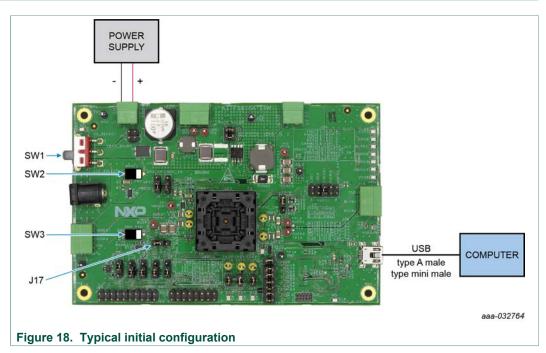
5.3 Installing FlexGUI software package

The FlexGUI software installation requires only extracting the zip file in a desired location.

- 1. If necessary, install the Java JRE and Windows 7 FlexGUI driver.
- 2. Download the latest FlexGUI (32-bit or 64-bit) version, available at http://www.nxp.com/KITFS85SKTEVM.
- 3. Extract all the files to a desired location on your PC. FlexGUI is started by running the batch file, \bin\flexgui-app-fs85.bat.

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6 Configuring the hardware for startup



<u>Figure 18</u> presents a typical hardware configuration incorporating the development board, power supply and Windows PC workstation.

To configure the hardware and workstation as illustrated in <u>Figure 18</u>, complete the following procedure:

1. Install jumpers for the configuration.

Table 16. Jumper configuration

Jumper	Configuration
J17	connect 1-2 (connect 5.0 V on DBG pin from the USB)

2. Configure switches for the configuration

Table 17. Switch configuration

Switch	Configuration
SW1	middle position (VBAT off)
SW2	open (WAKE1)
SW3	open (OTP programming off)

- 3. Connect the Windows PC USB port to the KITFS85SKTEVM development board using the provided USB 2.0 cable.
 - Set the DC power supply to 12 V and current limit to 1.0 A. With power turned off, attach the DC power supply positive and negative output to KITFS85SKTEVM V_{BAT} Phoenix connector (J1).
- 4. Turn on the power supply.
- 5. Close SW2.

Note: At this step, the product is in debug mode and all regulators are turned off. The user can then power up with OTP configuration or configure the mirror registers before power up. Power up is effective as soon as J17 jumper is removed.

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Using the KITFS85SKTEVM evaluation board 7

This section summarizes the overall setup. Detailed description is provided in the following sections.

Before starting the process, choose the mode you want to run the device.

- In Normal mode, the configuration comes from OTP fuses.
- In Debug mode, you can either use the current configuration from OTP fuse, if any, or use the OTP emulation mode to write in the mirror register.

The Normal mode or Debug mode is defined at startup depending on the DBG pin level.

- · Normal mode is set by tying DBG to ground
- Debug mode is set by setting DBG voltage to 5.0 V

In OTP emulation, you can overwrite the mirror registers from a given OTP fuse configuration. See Section 4.2.1 "OTP and mirrors registers" and Section 8.3 "Working with the Script editor" to define your configuration.

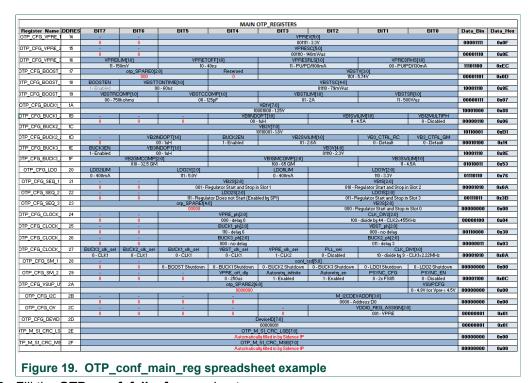
In OTP fuse configuration, use the configuration fused in the OTP, So, if a valid OTP fuse configuration exists, then it will be copied to the mirror registers at startup.

7.1 Generating the OTP configuration file

Define and generate your OTP configuration using the excel file FS85 FS84 OTP Config.xlsm . This file allows configuring the device for parameters controlled by the the main state machine and the fail-safe state machine.

To generate the script:

1. Fill the OTP_conf_main_reg sheet



2. Fill the OTP_conf_failsafe_reg sheet

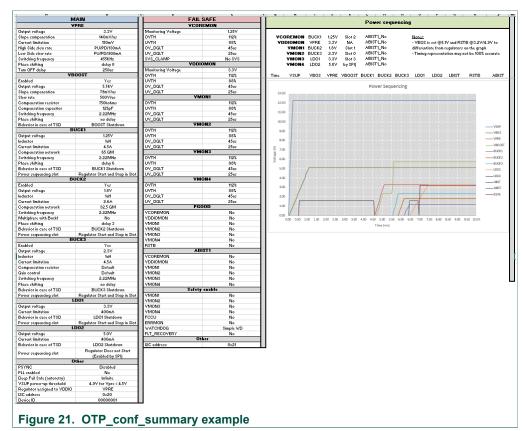
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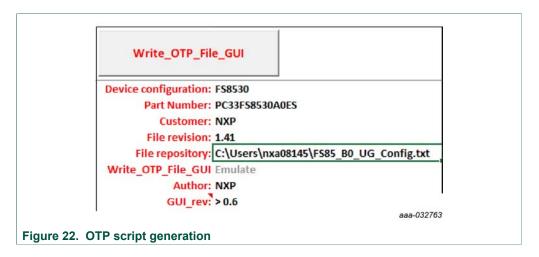
Figure 20. OTP_conf_failsafe_reg spreadsheet example

3. See the **OTP_conf_summary** sheet to review the complete configuration (main and fail-safe)



Generate the script in OTP_conf_file_generation sheet
 Once the configuration is ready, the user can generate the script file. Go to
 OTP_conf_file_generation, enter the path in the File repository and then click
 Write_OTP_File_GUI.

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7.2 Working in OTP emulation mode

At startup, the device always uses the content from the mirror register. This content can come from OTP fuse or from configuration written directly in the mirror register. OTP emulation means that the user can emulate the OTP writing in the mirror register. This allows trials before burning the OTP.

- 1. Configure the hardware. See Section 6 "Configuring the hardware for startup".
- 2. Launch the FlexGUI software.
- 3. Switch to Debug mode:
 - a. Place SW1 in TOP direction (VBAT switched On).
 - b. Close SW2 (WAKE1).

While in Debug mode, all regulators are turned Off.

- 4. Load the mirror registers to work in OTP emulation mode. See <u>Section 8.3 "Working</u> <u>with the Script editor"</u>.
- 5. Unplug jumper J17 1-2 to start the device with the mirror configuration setting.
 - a. If the mirror registers are filled (with a configuration using the Script editor), that configuration will be used in the emulation session.
 - b. If the mirror registers are not filled (with a configuration using the Script editor), the currently-programmed OTP fuse configuration will be used, if it exists.
 - c. Otherwise, the mirror registers are not filled and the OTP fuse is not burned, and the device will not start up.

As long as initialization phase is not closed by a first good WD_Answer, the WD will not start and regulators will stay alive. Also, as long as Debug mode is not exited by writing FS_STATES:[DBG_EXIT] bit to 1, the FS0b pin cannot be released.

6. Use the FlexGUI software to evaluate the device configured. See <u>Section 8 "Using FlexGUI"</u>.

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7.2.1 Example script: Closing initialization phase, disabling FCCU monitoring and releasing FS0b

The following script can be used to:

- Disable the WD (simple WD configuration is used here).
- Disable the FCCU monitoring.
 On the hardware kit, the FCCU1 is pulled to GND and FCCU2 is pulled to VDDIO, which is detected as error phase by default. Disabling the FCCU by SPI/I2C avoids safety issue at startup.
- · Close the initialization phase.
- · Exit the Debug mode.
- Release FS0b pin. This is valid only if WD is activated in OTP.
 Seven good consecutive WD answers are required to have the FLT_ERR_CNTR back to 0. This is one of the conditions to allow FS0b release.

Table 18. FS85 starting sequence example

Step	Register name	Value	Description
1	FS_WD_WINDOW	0x0200	WDW_WINDOWS[3:0] = 0x0 => Watchdog disabled
2	FS_NOT_WD_WINDOW	0xF50F	NOT of FS_WD_WINDOW
3	FS_I_SAFE_INPUTS	0x51C6	FCCU_CFG[1:0] = 0x0 => 0x1 => Monitoring by pair FCCU12_FLT_POL[0] = 1 => FCCU1 or 2 = 0 is a fault
4	FS_I_NOT_SAFE_INPUTS	0xAC18	NOT of FS_I_SAFE_INPUTS
5	FS_WD_ANSWER	0x5AB2	1st good WD answer (for simple WD selection in OTP) Close the initialization phase
6	FS_STATES	0x4000	DBG_EXIT[0]=1 => Exit Debug mode
7	FS_WD_ANSWER	0x5AB2	2nd good WD answer
8	FS_WD_ANSWER	0x5AB2	3rd good WD answer
9	FS_WD_ANSWER	0x5AB2	4th good WD answer
10	FS_WD_ANSWER	0x5AB2	5th good WD answer
11	FS_WD_ANSWER	0x5AB2	6th good WD answer
12	FS_WD_ANSWER	0x5AB2	7th good WD answer
13	FS_RELEASE_FS0B	0xB2A5	FS0b pin released (pulled to high level)
14	MFLAG2	0x40F1	Clear flags VSUPUV7; VPREUVL, VSUPUVL, WAKE1FLG
15	FS_OVUVREG_STATUS	0x4550	Clear UV status flags

This sequence can be sent using a script built with FlexGUI. See <u>Section 8.3.2 "Script sequence files"</u>.

7.3 Programming the device with an OTP configuration

The device configuration can be changed three times (see <u>Section 4.2.1 "OTP and mirrors registers"</u>). The programming steps are exactly the same as the OTP emulation mode up to step 6.

Then, the user has to burn the part with FlexGUI. See <u>Section 8.4.8 "OTP programming"</u>. Follow the instructions on the screen to proceed.

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8 Using FlexGUI

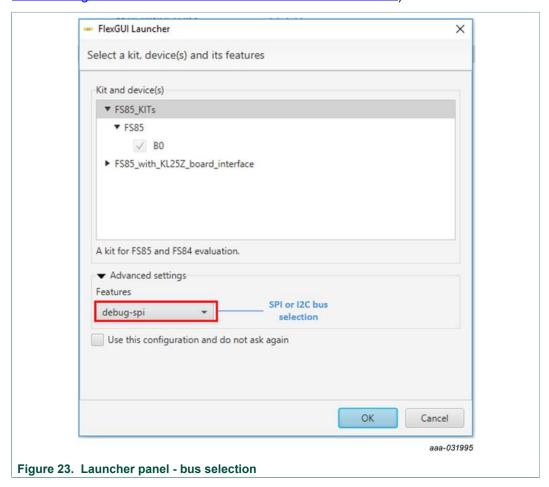
To follow the steps in this section, make sure that the board is connected using the appropriate hardware configuration (see Section 7.2 "Working in OTP emulation mode").

Note: It is recommended to use the latest version of FlexGUI.

8.1 Starting the FlexGUI application

After FlexGUI is launched with the *flexgui-app.bat* file, the FlexGUI launcher displays available kits.

Communication bus, SPI or I2C can be selected at this level. It is also possible to switch from one to the other using the communication tab from the main panel (see <u>Section 8.2</u> <u>"Establishing the connection between FlexGUI and the hardware"</u>).



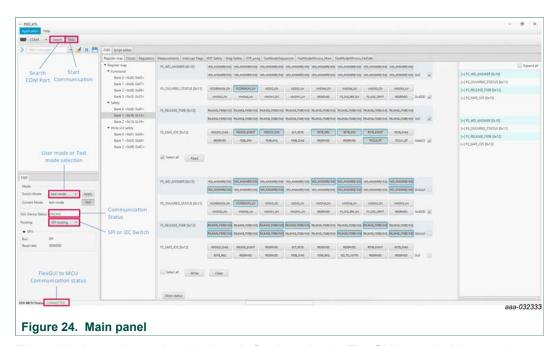
When the configuration is selected, click **OK**.

8.2 Establishing the connection between FlexGUI and the hardware

The board must be connected to the USB before establishing a connection.

- Click **Search** to detect the COM port of the board.
- · Click Start to enable the connection.

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<u>Figure 24</u> shows the mode selection. At first launch, the FlexGUI starts in User mode. The user can then decide to switch to Test mode using the Switch mode drop-down list followed by clicking **Apply**.

The **GUI-Device Status** field checks the connection from MCU to the device. The **ONLINE** status indicates a good connection, while **ERROR** status indicates an issue (e.g. V_{SUP} is not provided to the device).

The SPI/I2C communication bus can be changed at any time using the drop-down list. This change is managed by the onboard MCU to communicate with the desired bus.

It is also possible to change the clock frequency using this panel.

Note that in the case of I2C, most of the time, the default address used by the device are 0x20 for main and 0x21 for the fail-safe.

The I2C address is managed differently in Debug and Normal mode

- · Debug mode:
 - I2C address when debug mode pin is set to 5.0 V are 0x20 for main and 0x21 for failsafe.
 - The user can change this address in the mirror register. The new address is taken into account only after debug pin is released to 0 V.
- · Normal mode:
 - The address is burned in the OTP.

The user can read in which mode the device is operating. It is also possible to switch from user mode to test mode (and vice-versa).

The current mode is displayed only when Poll button is activated. If required, this has to be done at start up (Poll button is disabled by default). See <u>Figure 25</u>.

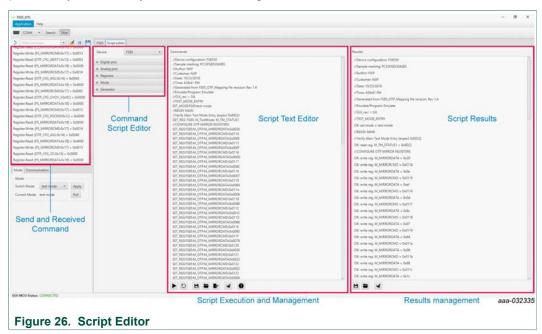
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To move from one mode to the other, select the mode with switch mode drop-down button and click **Apply** to validate. At this time, the current mode will be updated at the condition that Poll button is enabled.

8.3 Working with the Script editor

The register and OTP emulation can be configured with the script editor. This is particularly useful to try various OTP configurations in Emulation mode.



The main subareas of this panel are:

- **Send and receive command**: displays a summary of commands sent and received from the device
- Command script editor: builds commands to be sent to the device
- Script text editor: sends a sequence of register configurations from a text file or from command edited directly in this area
- Script results: displays result status of each command sent to the device

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8.3.1 Script text editor

Using Script editor, you can execute any command either directly or from a file. It is also possible to save and modify a script. Using the brush symbol, it is possible to clean windows if needed.

All commands have to follow a specific syntax. The Help menu describes commands available in the script editor and their syntax.

This help page describes commands available in the script editor and their format.

List of commands

- · SET_REG: sets value of a selected register.
- READ_REG: reads value of a selected register.
- . SET_DPIN: sets value of a selected digital pin.
- . GET_DPIN: gets value of a selected digital pin.
- GET_APIN: gets value of a selected analog pin. Returned value is in mV.
- · PAUSE: shows a dialog with user defined message. The script is paused until the user cofirms the dialog.
- . EXIT: stops execution of the script.
- . SET_MODE: sets device mode. List of modes depends on a device.

Command format

The following table describes command parameters. All paramaters are mandatory.

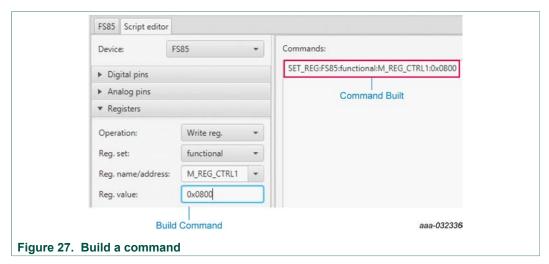
	1st parameter	2nd parameter	3rd parameter	4th parameter	5th parameter
SET_REG	Device	Reg. set	Reg. name / Reg. address	Reg. value	
GET_REG	Device	Reg. set	Reg. name / Reg. address	*	
SET_DPIN	Device	Pin name	Dig. pin value	-	-
GET_DPIN	Device	Pin name		-	-
GET_APIN	Device	Pin name	S .	-	
PAUSE	Message		(*)		
EXIT	*:		1.5	-	-

Description of command parameters mentioned in the table above:

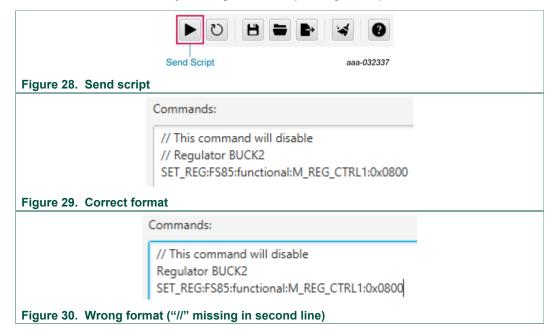
- · Device: device name (alias used in application).
- Reg. set: register set name. Register sets allows to associate registers which have similar function.
- · Reg. name: register name as defined in datasheet.
- . Reg. address: register address in decimal or hexadecimal (with 0x prefix) format.
- . Reg. value: register value in decimal or hexadecimal (with 0x prefix) format.
- Pin name: name of digital or analog pin as defined in device datasheet.
- Dig. pin value: value of digital pin. Allowed strings are 'low' and 'high'
- Message: a message to be displayed in a dialog. It cannot contain ':' character, which is used as delimiter of parameters.
- Mode: name of a device mode.

Figure 27 shows an example to build a command from the panel.

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The value 0x0800 is sent to the register M_REG_CTRL1 (BUCK2DIS). The user can then send it to the device by clicking the arrow (see <u>Figure 28</u>).



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8.3.2 Script sequence files

The Script editor allows the user to save script sequence files. A script sequence file is text file that contains a set of commands sent to the device in the order they are written, as shown in the following example.

```
// FS85_Release_FS0b
SET_REG:FS85:safety:FS_WD_WINDOW:0x0200
SET_REG:FS85:safety:FS_NOT_WD_WINDOW:0xF50F
SET_REG:FS85:Write_INIT_Safety:FS_I_SAFE_INPUTS:0x51C6
SET_REG:FS85:Write_INIT_Safety:FS_I_NOT_SAFE_INPUTS:AC18
SET_REG:FS85:safety:FS_WD_ANSWER:0x5AB2
```

Note: Comments can be added with a // prefix.

8.4 Understanding the FS85 workspace

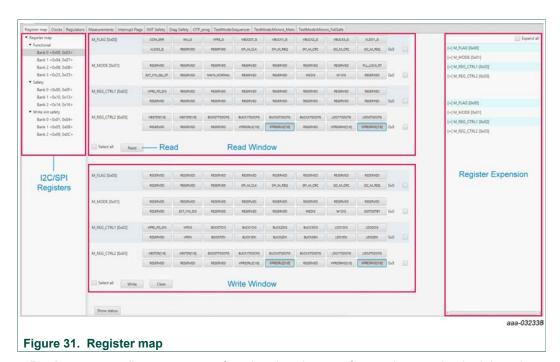
The FS85 workspace consists of several tabs, each dedicated to a specific aspect of device functionality or configuration.

- Register map
- Clocks
- Regulators
- Measurements
- · Interrupt flags
- · INIT safety
- Diag safety
- · OTP programming
- TestMode:Sequencer
- TestMode:Mirrors Main and TestMode:Mirrors Failsafe

8.4.1 Register map

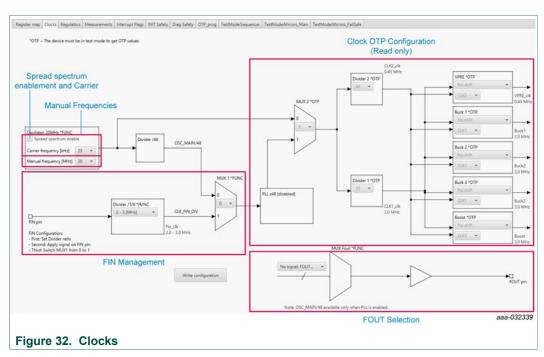
All SPI/I2C registers can be accessed in write and read mode using this tab.

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- **Register map**: allows access to functional register, safety register and write init register which are accessible only during initialization phase
- Read: allows you to read any register either individually or by bank
- Write: allows you to write any register either individually or by bank
- Register expansion: displays the value of each device parameter

8.4.2 Clocks



This tab allows:

OTP:

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• Read current OTP configuration (write operation is not possible). To display the accurate data, the device needs to operate in Test mode.

SPI/I2C:

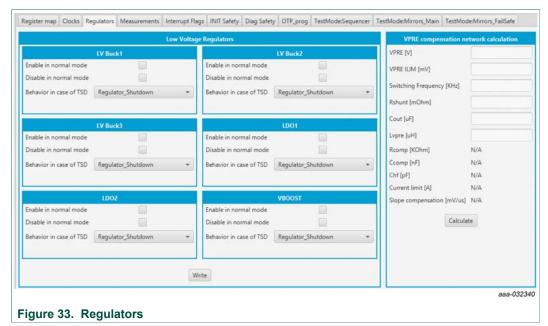
- · Configure the device to work with FIN input
- · Select the signal to apply on FOUT pin
- · Play with manual frequencies and spread spectrum

8.4.3 Regulators

The regulator has two main areas:

- · Low voltage (LV) regulators configuration
- VPRE compensation network calculation

Each regulator can either be enabled or disabled by SPI/I2C. The thermal shutdown behavior can be configured to either shutdown the regulator, or shutdown the regulator and transition to deep fail-safe. The write button applies to the entire table. The VPRE compensation network calculator helps to define the value for VPRE external compensation network.

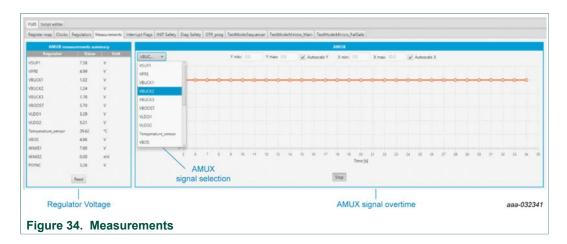


8.4.4 Measurements

This tab enables two features:

- Read any of the AMUX signals over time
- Display regulator voltage summary

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8.4.5 Interrupt flags

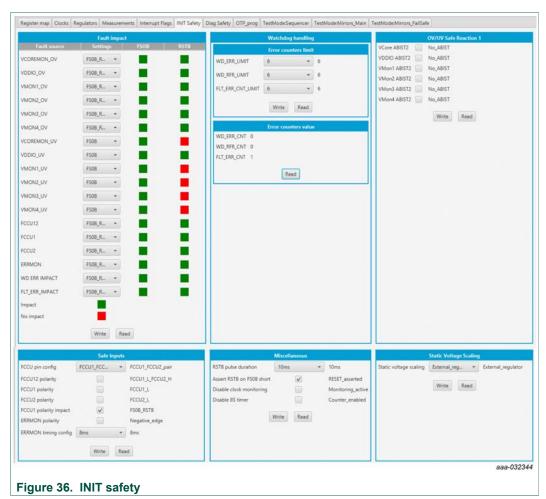
This tab allows you to set or clear flags. It is also possible to mask the interruption.



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8.4.6 INIT safety

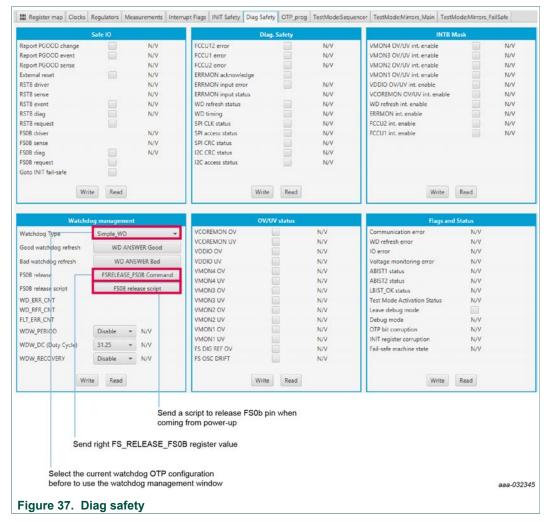
This tab allows you to manage all registers that can be configured to close the initialization phase. Note that the initialization phase is closed by the first good watchdog refresh before 256 ms timeout.



8.4.7 Diag safety

The watchdog type configured in the OTP has to be manually selected in the drop-down list to play with the watchdog features. If the user is not aware about the type of watchdog configured in the OTP, it can be found in TestMode:Mirrors_Failsafe and Miscellaneous tabs.

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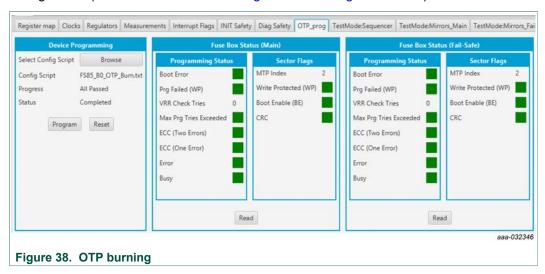
The FS_Release_FS0b command calculates and sends the right secure16-bit word to release FS0b.

A simplified way to release FS0b after power up is to, first, select the right type of watchdog configured in the OTP, then, hit FS0b Release script button. This sends the right sequence to close the initialization sequence, sets the error counter back to 0, then releases FS0b.

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8.4.8 OTP programming

This tab allows you to burn the OTP using a script generated by the excel file OTP configuration (see Section 7.1 "Generating the OTP configuration file ").



To set up the hardware before OTP burning, see <u>Section 7.3 "Programming the device</u> with an OTP configuration".

See Figure 38 and follow the steps:

- Browse and load the script file you want to burn. The program button will then be available.
- · Click Program.

FlexGUI pops up to turn the 8.0 V On, and then turns Off. Note that the blue LED on the board indicates that an 8.0 V voltage is available on the Debug pin. This voltage is used only during the burning process, and should not be applied in any other configuration. At the end of the first OTP programming, the MTP index = 1, WP, BE and CRC flags are green.

The Sector Flags area provides status <u>Table 19</u> provides the state of main flags after a read. This helps to determine how many times the part was burned.

Table 19. OTP burning flag status

OTP burning step	BE	WP	CRC	MTP Index
OTP not burn Mirrors Empty	Red	Red	Red	1
OTP not Burn Mirrors Filled	Red	Red	Green	1
1	Green	Green	Green	1
2	Green	Green	Green	2
3	Green	Green	Green	3

Example shown in Figure 38 corresponds to the OTP burning step 2 from Table 19.

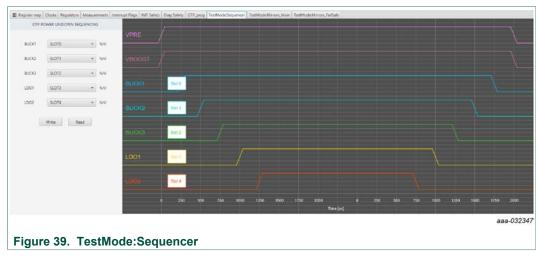
To check if a valid OTP configuration is already burned, switch V_{BAT} Off, then On, and start the device. The device starts with the OTP configuration.

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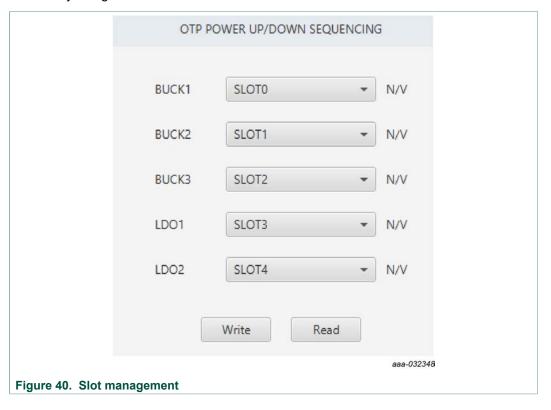
8.4.9 TestMode:Sequencer

The sequencer allows you to display the slot configuration for the device. To be able to access this tab, the device has to be in Test mode. The configuration is read from mirror register. It is possible to modify it and update the mirror register.

As an example, the slot sequence is filled at start up with the content of OTP fuses. Then the user can decide to modify any of the configurations coming from the OTP fuse. Note that all these actions are done with Debug pin at 5.0 V and in test mode.



Use the drop-down button (see <u>Figure 40</u>) to select the appropriate slot. The selection configuration can be sent to the device by clicking Write button. The current status can be read by using Read button.



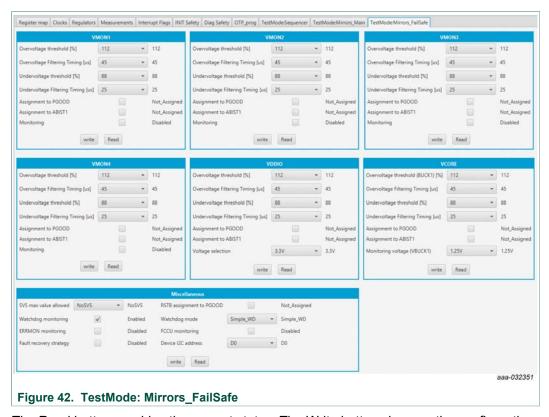
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8.4.10 TestMode:Mirrors_Main and TestMode:Mirrors_Failsafe

The TestModeMirrors_Main and TestModeMirrors_FailSafe tabs allow access to the OTP main mirrors and fail-safe registers. These tabs are available in Test mode.



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The Read button provides the current status. The Write button changes the configuration in mirror register. This can be useful, for example, to modify few parameters from OTP fuse to start up the board.

9 References

- [1] **KITFS85SKTEVM** detailed information on this board, including documentation, downloads, and software and tools http://www.nxp.com/KITFS85SKTEVM
- [2] FS8500 product information on FS8500, Safety system basis chip for S32 microcontrollers, fit for ASIL D http://www.nxp.com/FS8500
- [3] **FS8400** product information on FS8400, Safety system basis chip for S32 microcontroller, fit for ASIL B http://www.nxp.com/FS8400
- [4] FS85_FS84_OTP_Config.xlsm OTP configuration file

10 Revision history

Revision history

	to the state of th				
Rev	Date	Description			
v.2	20190220	 Global: reorganized content to match latest template Section 4.3.5: updated Table 12 Section 6: updated the configuration procedure Section 8.4.7: updated Figure 37 Section 8.4.9: updated Figure 39 and Figure 40 Section 8.4.10: updated Figure 41 			
v.1	20190118	Initial version			

UM11183

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